

ALPHA® HiTech™ CU32-380

低粘度底部填充剂

概述

ALPHA HiTech CU32-380 是一种单组份毛细底部填充剂,设计用于保护印刷电路板上芯片 封装的组装。 产品能实现以下特点和优点的平衡:

- 低粘度,拥有快速高效的流动性
- 低吸湿性
- 释放大面积应力,主应力是元件和基板之间的热膨胀系数(CTE)的不匹配
- 优异的抗冲击力; 在 10,000 次循环后, 仍保持电路板的冲击弯曲特性
- 优异的电阻跌落冲击
- 无卤素
- 符合 RoHS 指令 2011/65/EU

使用该产品前,请阅读整份技术数据表

应用

| 存储 | 解冻 | 应用 | 固化 | 安全 |
|--|------------|---|--------------------------------------|--|
| 7. 存放温度 2. 空,以保证产品稳定。 3. 垂直放置,尖端朝下 | - 从冰箱中取出产品 | ALPHA HiTech CU32-380 可在室温 条件下高 效使用。 | 为保证充分在 130℃ 条件至少 (对流) (对流) (对流) (对流) | 虽然 ALPHA HiTech CU32-380 没有毒性,但在使用 过程会产生少量反应 和分解气体。应将这 些气体从工作空间中 充分排出。其他安全 性信息,请参阅安全 数据表;最新版本的 安全数据表可从 alphaassembly.com 下载。available at AlphaAssembly.com |



TECHNICAL BULLETIN

技术数据

| 类别 | 规格 | | | |
|---|----------------|--|--|--|
| 未固化材料属性典型值 | | | | |
| 外观 | 黑色 | | | |
| 粘度 (RVDV-II Brookfield #4 @20rpm @25°C) | 300 – 800 cps | | | |
| 闪点 | >200 °C | | | |
| 使用期 @ 25°C | 3 天 | | | |
| 保质期< -20°C | 6 个月 | | | |
| 包装规格 | 10cc, 30cc 针筒装 | | | |
| 固化后材料属性典型值 | | | | |
| 玻璃化转变温度(Tg),TMA 方法 | 89 ± 5°C | | | |
| 热膨胀系数(CTE, α ₁ , <tg)< td=""><td>57 ± 10 ppm</td></tg)<> | 57 ± 10 ppm | | | |
| 热膨胀系数(CTE, α ₂ , >Tg) | 199 ± 20 ppm | | | |
| 硬度(Shore D) | 80 – 90 | | | |
| 存储模量@25°C (Gpa via DMA) | 1.27 | | | |

联络资料

如需要确认这是最新版本,请联络 Assembly@MacDermidAlpha.com

www.macdermidalpha.com

| - | 北美 |
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Also read carefully warning and safety information on the Safety Data Sheet. This data sheet contains technical information required for safe and economical operation of this product. READ IT THOROUGHLY PRIOR TO PRODUCT USE. Emergency directory assistance: Chemtrec 1 - 800 - 424 - 9300.

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ELECTRONICS SOLUTIONS

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